

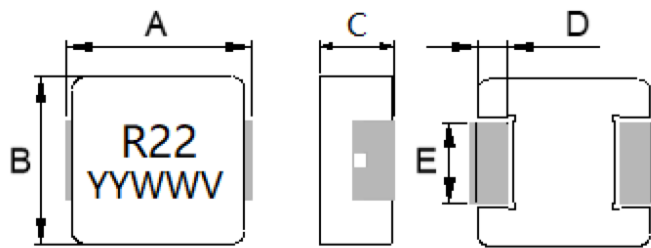
## 1. Part No. Expression

**PIAQ 1 2 6 5 H T R 2 2 M N**

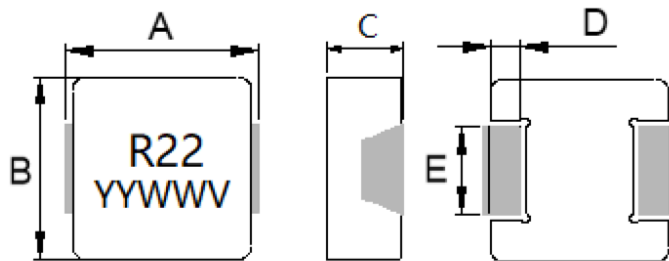
(a) (b) (c) (d) (e) (f)

- |                    |                     |
|--------------------|---------------------|
| (a) Series Code    | (d) Inductance Code |
| (b) Dimension Code | (e) Tolerance Code  |
| (c) Material Code  | (f) Special Code    |

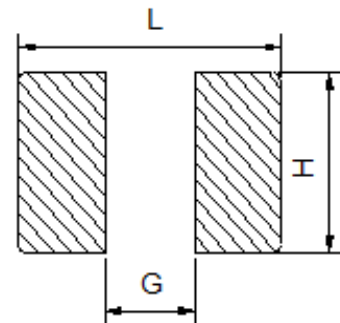
## 2. Configuration & Dimensions (Unit: mm)



Leadframe



non-leadframe



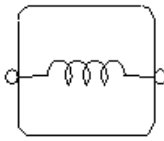
Recommended PCB Layout

- Note:
1. The above PCB layout reference only.
  2. Recommend solder paste thickness at 0.15 mm and above.
  3. Marking: Top= Inductance Code, Bottom=YYWWV (Year/World week, V:P/N), Black

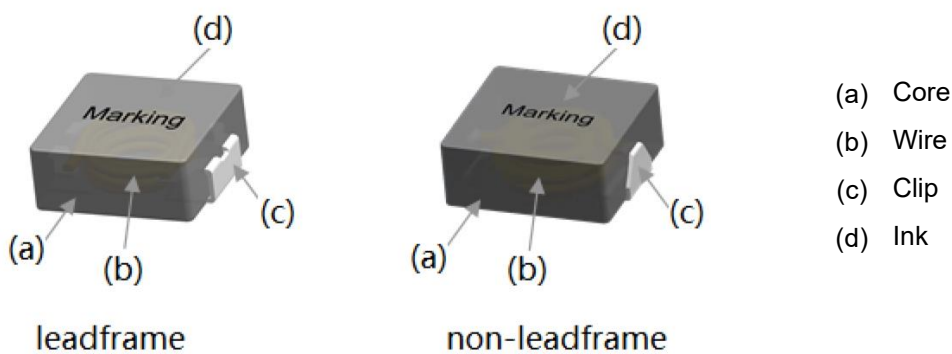
| A        | B        | C       | D       | E                              | L        | G       | H       |
|----------|----------|---------|---------|--------------------------------|----------|---------|---------|
| 13.5±0.5 | 12.6±0.2 | 6.2±0.3 | 2.3±0.3 | See Electrical Characteristics | 14.5 Ref | 8.0 Ref | 5.0 Ref |

NOTE: Specifications subject to change without notice. Please check our website for latest information.

## 3. Schematic



## 4. Material List



## 5. General Specifications

- (a) Reliability test for this part meets AEC-Q200 standard.
- (b) Operating Temp.: -55°C to +180°C (including self-temperature rise)
- (c) Storage Temp.: -55°C to +180°C (on board)
- (d) All test data referenced to 25°C ambient.
- (e) Heat Rated Current (Irms) will cause the coil temperature rise approximately  $\Delta T$  of 40°C.
- (f) Saturation Current (Isat) will cause inductance L0 to drop approximately 30%.
- (g) Rated Current: The lower value of Isat and Irms.
- (h) Part Temperature (Ambient + Temp. Rise): Should not exceed 180°C under worst case operating conditions.
- (i) Maximum Operating Voltage: 80V
- (j) Storage Condition (Component in its packaging)
  - i) Temperature: Less than 40°C
  - ii) Humidity: Less than 60% RH

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## 6. Electrical Characteristics

| Part No         | Inductance<br>@ 0A (μH)<br>± 20% | I <sub>rms</sub><br>(A) |     | I <sub>sat</sub><br>(A) |      | DCR<br>(mΩ) |      | E<br>(mm)<br>±0.3 | Type          |
|-----------------|----------------------------------|-------------------------|-----|-------------------------|------|-------------|------|-------------------|---------------|
|                 |                                  | Typ                     | Max | Typ                     | Max  | Typ         | Max  |                   |               |
| PIAQ1265HTR22MN | 0.22                             | 45                      | 40  | 75                      | 70   | 0.40        | 0.46 | 4.7               | non-leadframe |
| PIAQ1265HTR33MN | 0.33                             | 43                      | 37  | 68                      | 63   | 0.55        | 0.62 | 4.7               | non-leadframe |
| PIAQ1265HTR47MN | 0.47                             | 40                      | 35  | 65                      | 60   | 0.80        | 0.90 | 4.7               | non-leadframe |
| PIAQ1265HT1R0MN | 1.00                             | 35                      | 30  | 37                      | 33   | 1.40        | 1.70 | 4.0               | non-leadframe |
| PIAQ1265HT1R2MN | 1.20                             | 30                      | 25  | 35                      | 32   | 1.70        | 2.00 | 4.0               | non-leadframe |
| PIAQ1265HT1R5MN | 1.50                             | 27                      | 23  | 31                      | 27   | 2.20        | 2.53 | 4.0               | non-leadframe |
| PIAQ1265HT2R2MN | 2.20                             | 25                      | 22  | 27                      | 23   | 3.2         | 3.7  | 4.7               | leadframe     |
| PIAQ1265HT3R3MN | 3.30                             | 22                      | 20  | 24                      | 21   | 4.8         | 5.6  | 4.7               | leadframe     |
| PIAQ1265HT4R7MN | 4.70                             | 19                      | 17  | 22                      | 20   | 6.7         | 7.7  | 4.7               | leadframe     |
| PIAQ1265HT5R6MN | 5.60                             | 17                      | 15  | 20                      | 18   | 8.0         | 9.2  | 4.7               | leadframe     |
| PIAQ1265HT6R8MN | 6.80                             | 15                      | 13  | 17                      | 15   | 10.3        | 12   | 4.7               | leadframe     |
| PIAQ1265HT8R2MN | 8.20                             | 13                      | 12  | 16                      | 14   | 11.8        | 13.6 | 4.7               | leadframe     |
| PIAQ1265HT100MN | 10.0                             | 12                      | 11  | 15                      | 13   | 13.8        | 16.0 | 4.7               | leadframe     |
| PIAQ1265HT120MN | 12.0                             | 11                      | 10  | 12.5                    | 11.5 | 17.3        | 20.0 | 4.7               | leadframe     |
| PIAQ1265HT150MN | 15.0                             | 9.5                     | 8.5 | 12                      | 11   | 21          | 25   | 4.7               | leadframe     |
| PIAQ1265HT220MN | 22.0                             | 8.5                     | 7.5 | 9.0                     | 8.0  | 30          | 35   | 4.7               | leadframe     |
| PIAQ1265HT330MN | 33.0                             | 7.6                     | 6.5 | 8.0                     | 7.0  | 46          | 55   | 4.7               | leadframe     |

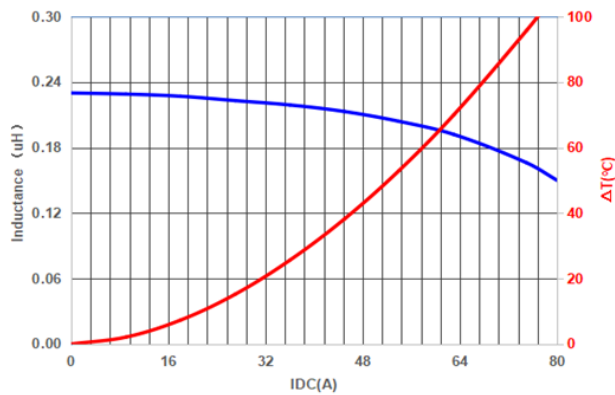
Note:

Test Frequency: 1.0V/100KHz

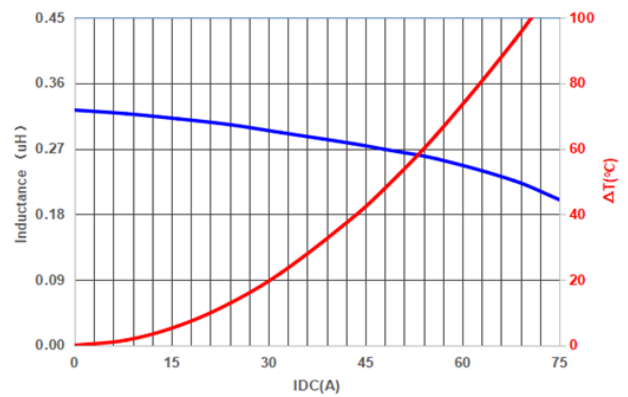
NOTE: Specifications subject to change without notice. Please check our website for latest information.

## 7. Characteristics Curve

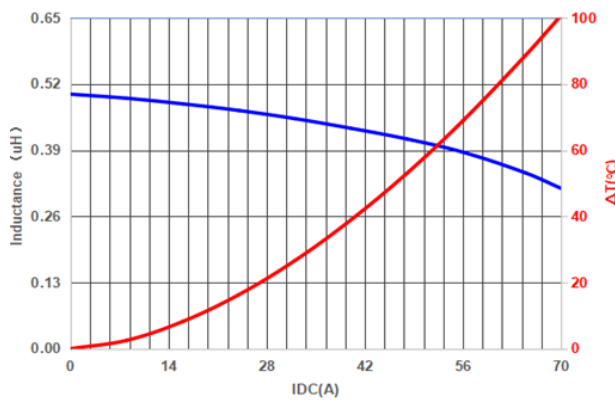
PIAQ1265HTR22MN



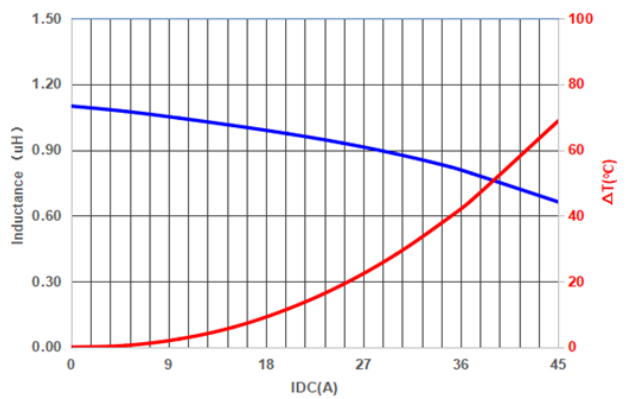
PIAQ1265HTR33MN



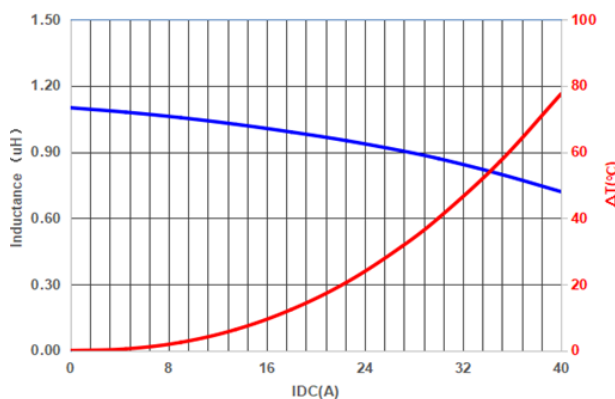
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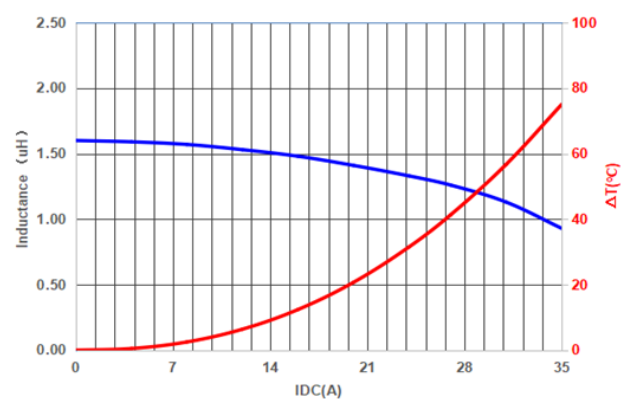
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PIAQ1265HT1R2MN

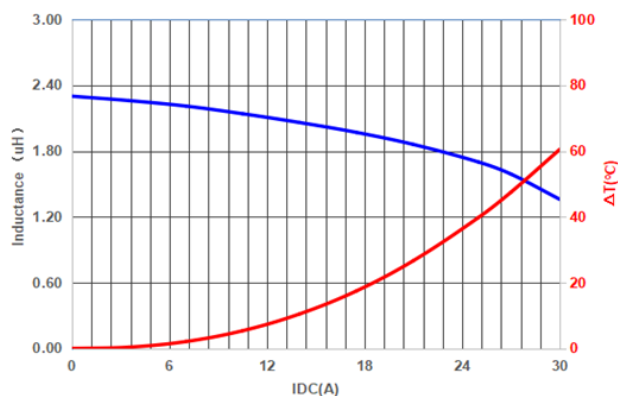


PIAQ1265HT1R5MN

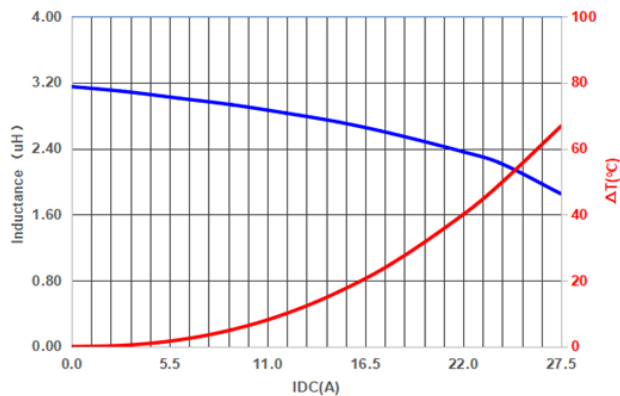


NOTE: Specifications subject to change without notice. Please check our website for latest information.

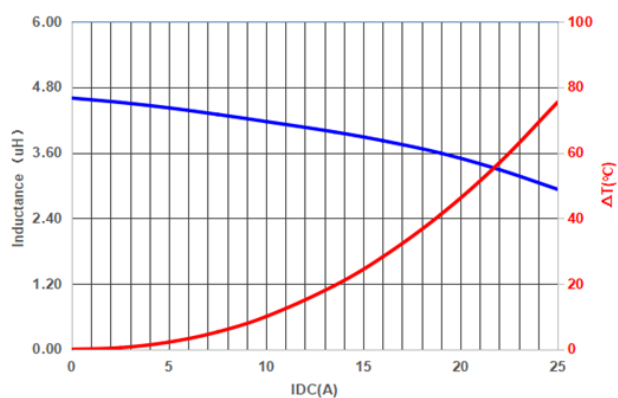
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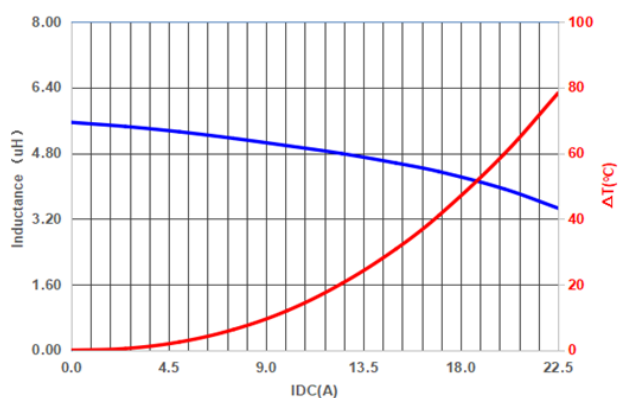
PIAQ1265HT3R3MN



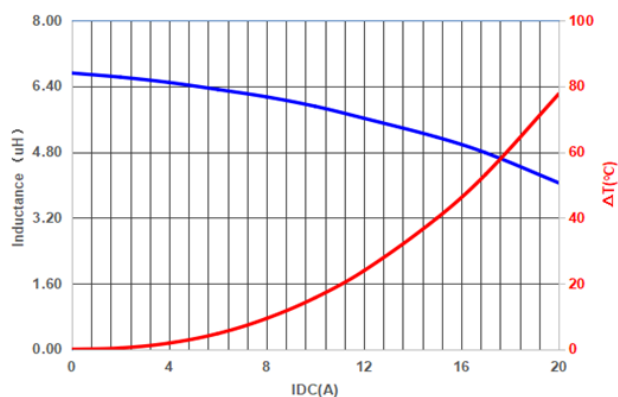
PIAQ1265HT4R7MN



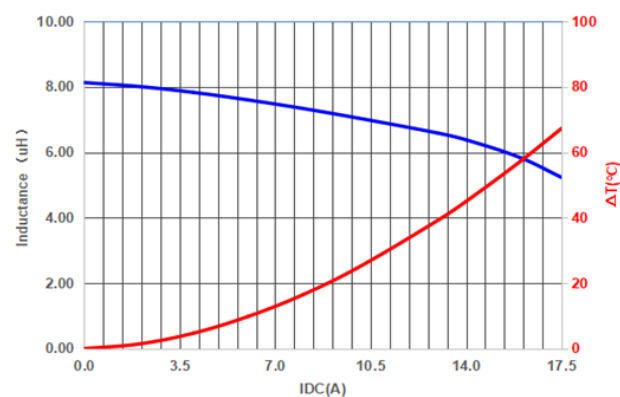
PIAQ1265HT5R6MN



PIAQ1265HT6R8MN

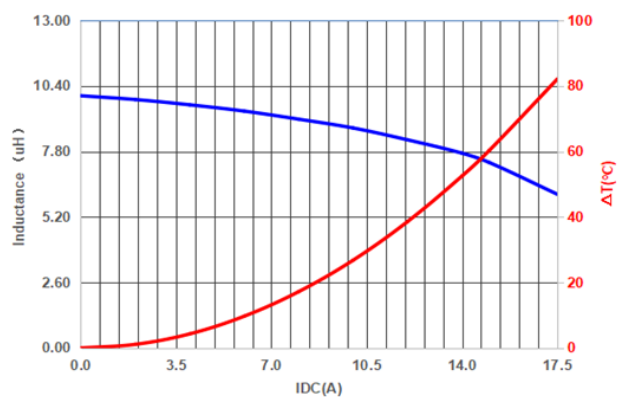


PIAQ1265HT8R2MN

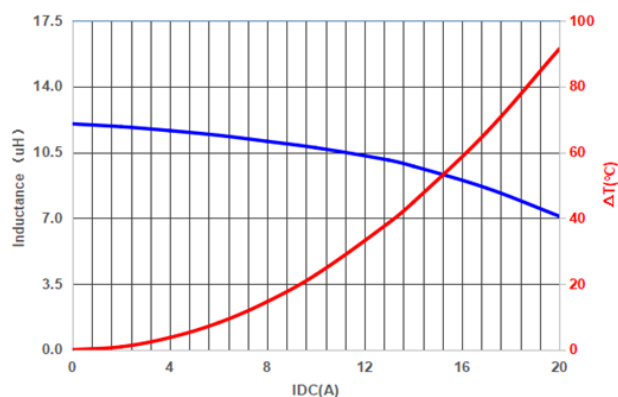


NOTE: Specifications subject to change without notice. Please check our website for latest information.

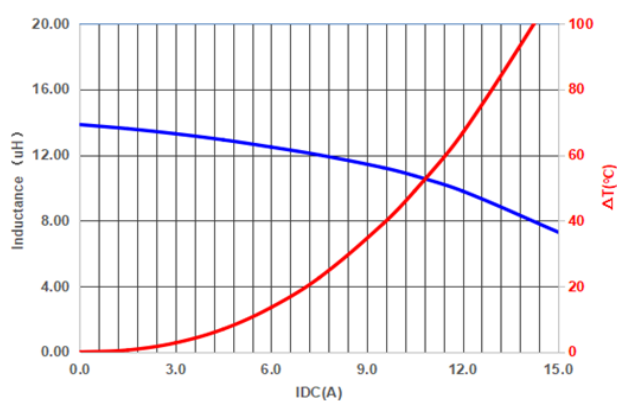
PIAQ1265HT100MN



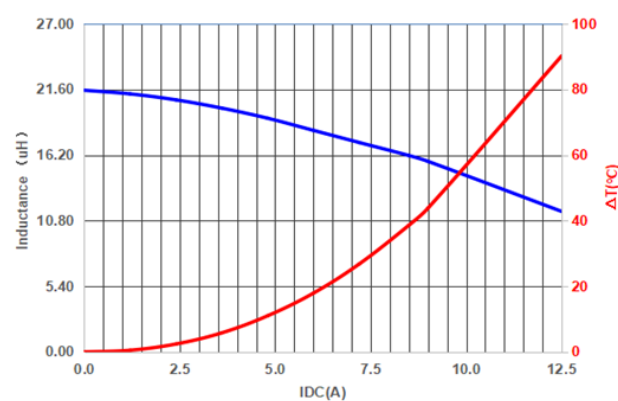
PIAQ1265HT120MN



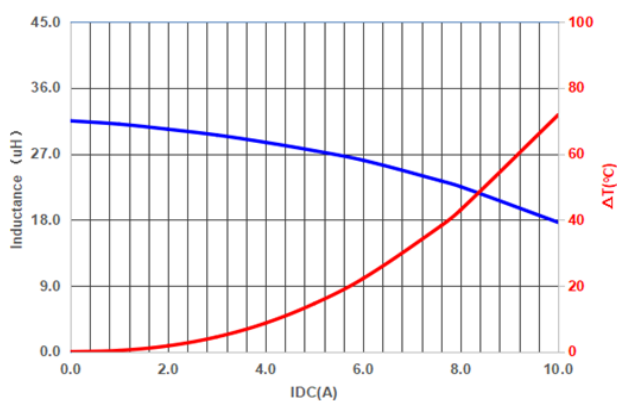
PIAQ1265HT150MN



PIAQ1265HT220MN



PIAQ1265HT330MN



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## 8. Soldering Specification

Mildly activated rosin fluxes are preferred. Our terminations are suitable for re-flow soldering systems. If hand soldering cannot be avoided, the preferred technique is the utilization of hot air soldering tools.

### 8-1. IR Soldering Reflow

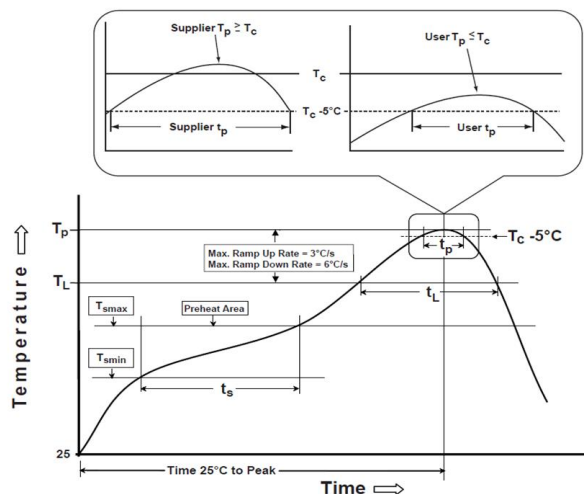
Recommended temperature profiles for lead free re-flow soldering in Figure 1, Table 1.1 & 1.2 (J-STD-020F).

### 8-2. Iron Reflow

Products attachment with a soldering iron is discouraged due to the inherent process control limitations. In the event that a soldering iron must be employed the following precautions are recommended (Figure 2).

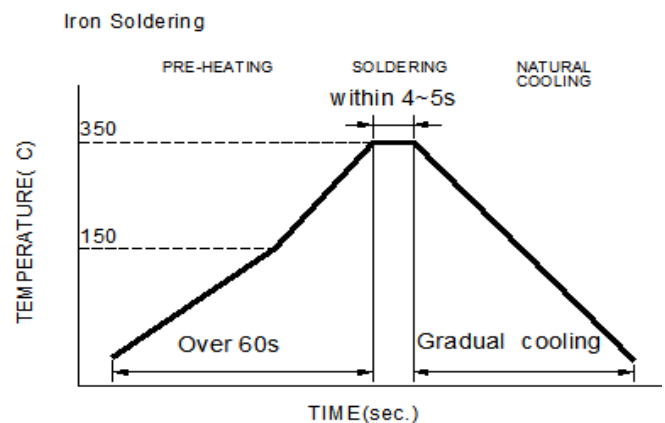
Note:

- Preheat circuit and products to 150°C.
- 350°C tip temperature (Max.)
- Never contact the ceramic with the iron tip
- 1.0mm tip diameter (Max.)
- Use a 20 watt soldering iron with tip diameter of 1.0mm
- Limit soldering time to 4~5 sec.



Reflow times: 3 times Max

Figure 1: IR Soldering Reflow



Iron Soldering times : 1 times max

Figure 2: Iron soldering temperature profiles

NOTE: Specifications subject to change without notice. Please check our website for latest information.

**Table (1.1) Reflow Profiles**

|                                                                                            |                  |
|--------------------------------------------------------------------------------------------|------------------|
| Profile Type:                                                                              | Pb-Free Assembly |
| Preheat                                                                                    |                  |
| -Temperature Min ( $T_{smin}$ )                                                            | 150°C            |
| -Temperature Max ( $T_{smax}$ )                                                            | 200°C            |
| -Time ( $t_s$ ) from ( $T_{smin}$ to $T_{smax}$ )                                          | 60-120seconds    |
| Ramp-up rate ( $T_L$ to $T_p$ )                                                            | 3°C /second max. |
| Liquids temperature ( $T_L$ )                                                              | 217°C            |
| Time ( $t_L$ ) maintained above $T_L$                                                      | 60-150 seconds   |
| Classification temperature ( $T_c$ )                                                       | See Table (1.2)  |
| Time ( $t_p$ ) at $T_c - 5^\circ\text{C}$ ( $T_p$ should be equal to or less than $T_c$ .) | < 30 seconds     |
| Ramp-down rate ( $T_p$ to $T_L$ )                                                          | 6°C /second max. |
| Time 25°C to peak temperature                                                              | 8 minutes max.   |

**T<sub>p</sub>**: maximum peak package body temperature, **T<sub>c</sub>**: the classification temperature.

For user (customer) **T<sub>p</sub>** should be equal to or less than **T<sub>c</sub>**.

**Table (1.2) Package Thickness/Volume and Classification Temperature ( $T_c$ )**

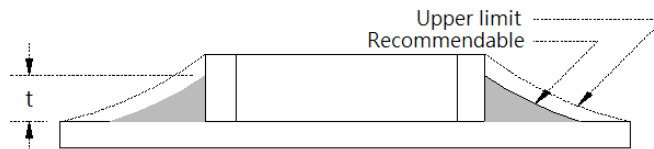
|                  | Package Thickness | Volume mm <sup>3</sup> <350 | Volume mm <sup>3</sup> 350-2000 | Volume mm <sup>3</sup> >2000 |
|------------------|-------------------|-----------------------------|---------------------------------|------------------------------|
| PB-Free Assembly | <1.6mm            | 260°C                       | 260°C                           | 260°C                        |
|                  | 1.6-2.5mm         | 260°C                       | 250°C                           | 245°C                        |
|                  | ≥2.5mm            | 250°C                       | 245°C                           | 245°C                        |

Reflow is referred to standard IPC/JEDEC J-STD-020F.

### 8-3. Soldering Volume

Accordingly increasing the solder volume, the mechanical stress to product is also increased. Exceeding solder volume may cause the failure of mechanical or electrical performance. Solder shall be used not to be exceeded as shown in the Figure below.

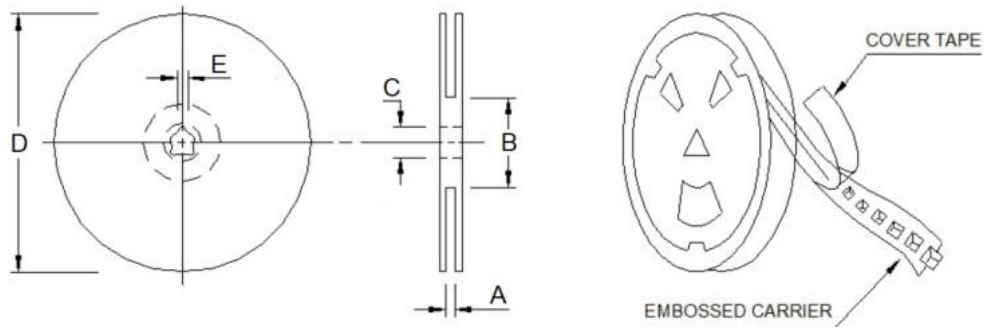
Minimum fillet height = soldering thickness + 25% product height.



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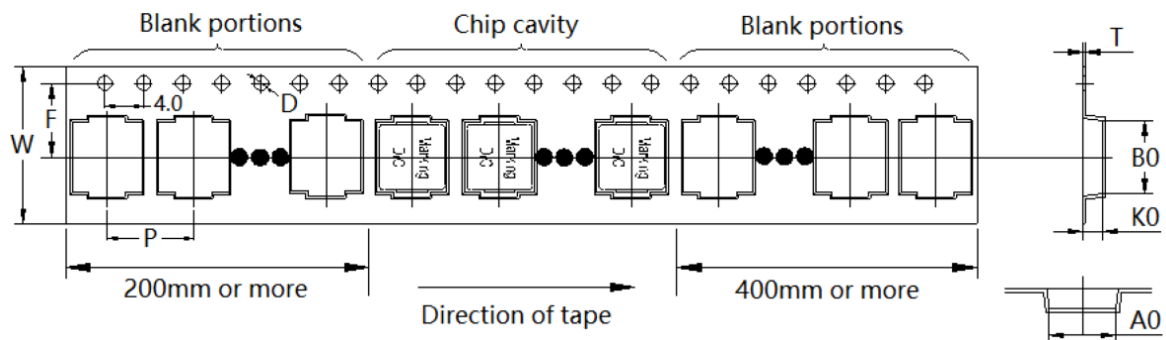
## 9. Packaging Information

### 9-1. Reel Dimension (Unit: mm)



| Type     | A        | B         | C        | D         | E       |
|----------|----------|-----------|----------|-----------|---------|
| 13"x24mm | 24.4 Ref | 100.0 Ref | 13.5 Ref | 330.0 Ref | 2.0 Ref |

### 9-2. Tape Dimension (Unit: mm)



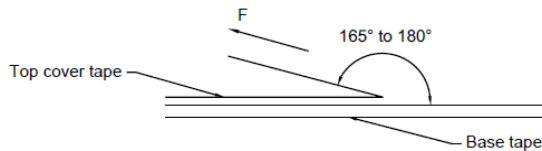
| B0         | A0         | K0        | P          |
|------------|------------|-----------|------------|
| 14.10±0.10 | 12.90±0.10 | 7.00±0.10 | 16.00±0.10 |
| W          | F          | T         | D          |
| 24.00±0.30 | 11.50±0.10 | 0.35±0.10 | 1.50±0.10  |

NOTE: Specifications subject to change without notice. Please check our website for latest information.

## 9-3. Packaging Quantity (Unit: Pcs)

|            |     |
|------------|-----|
| Chip/ Reel | 500 |
|------------|-----|

## 9-4. Tearing Off Force



The force for tearing off cover tape is according to the follow table, in the arrow direction under the following conditions.

(Referenced ANSI/EIA-481-D-2008 of 4.11 standard)

| Room Temp. (°C) | Room Humidity (%) | Room atm (hPa) | Tearing Speed (mm/min) |
|-----------------|-------------------|----------------|------------------------|
| 5~35            | 45~85             | 860~1060       | 300±10                 |

| Tape Size                 | 8 mm   | 12 to 56 mm | 72 mm or Wider |
|---------------------------|--------|-------------|----------------|
| Tearing Off Force (grams) | 10~100 | 10~130      | 10~150         |

## Application Notice

### 1. Storage Conditions

To maintain the solderability of terminal electrodes:

- (a) Products meet IPC/JEDEC J-STD-020F standard-MSL, level 1.
- (b) Recommended products should be used within 12 months from the time of delivery.
- (c) The packaging material should be kept where no chlorine or sulfur exists in the air.

### 2. Transportation

- (a) Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
- (b) Vacuum pick up is strongly recommended for individual components.
- (c) Bulk handling should ensure that abrasion and mechanical shock are minimized.

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